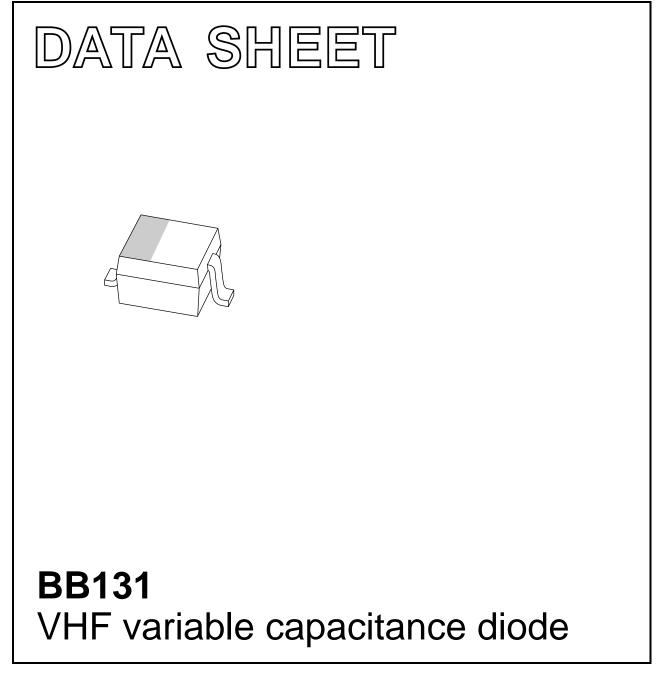
# DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1998 Sep 15 2004 Feb 10



#### FEATURES

- Excellent linearity
- Very small plastic SMD package
- C28: 1 pF; ratio: 14.

#### APPLICATIONS

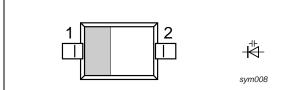
- Electronic tuning in satellite tuners
- Tunable coupling
- VCO.

### DESCRIPTION

The BB131 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small plastic SMD package.

#### PINNING

PIN	DESCRIPTION
1	cathode
2	anode



#### Marking code: P1.

The marking bar indicates the cathode.

Fig.1 Simplified outline (SOD323; SC-76) and symbol.

### **ORDERING INFORMATION**

TYPE		PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION	
BB131	_	plastic surface mounted package; 2 leads	SOD323	

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V <sub>R</sub>	continuous reverse voltage		30	V
١ <sub>F</sub>	continuous forward current		20	mA
T <sub>stg</sub>	storage temperature		+150	°C
Tj	operating junction temperature	-55	+125	°C

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## BB131

### CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$  unless otherwise specified.

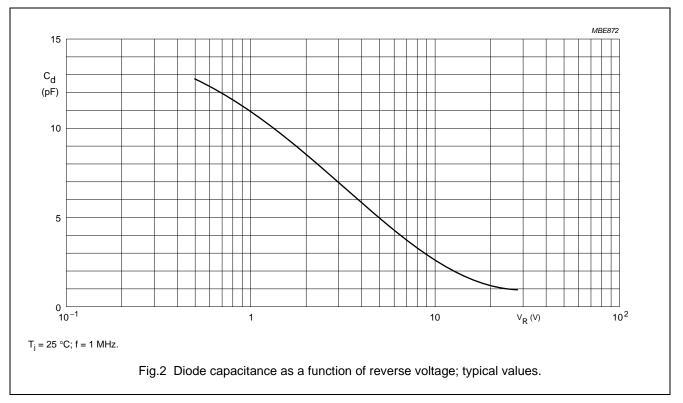
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>R</sub>	reverse current	V <sub>R</sub> = 30 V; see Fig.3	-	10	nA
		$V_R = 30 \text{ V}; \text{ T}_j = 85 \text{ °C}; \text{ see Fig.3}$	-	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz; note 1	-	3	Ω
C <sub>d</sub>	diode capacitance	$V_R = 0.5 V$ ; f = 1 MHz; see Figs 2 and 4	8	17	pF
		$V_R = 28 \text{ V}; \text{ f} = 1 \text{ MHz}; \text{ see Figs 2 and 4}$	0.7	1.055	pF
$\frac{C_{d(0.5V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	12	16	

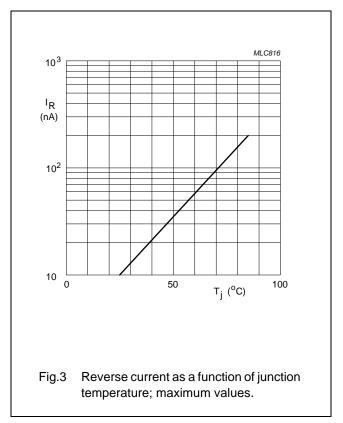
#### Note

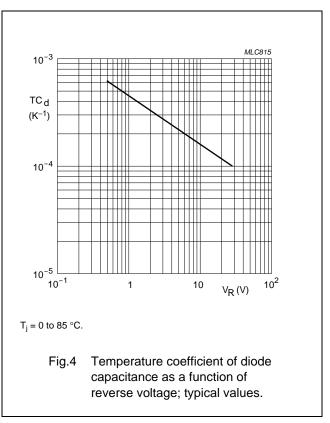
1.  $V_R$  is the value at which  $C_d = 9 \text{ pF}$ .

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### **GRAPHICAL DATA**

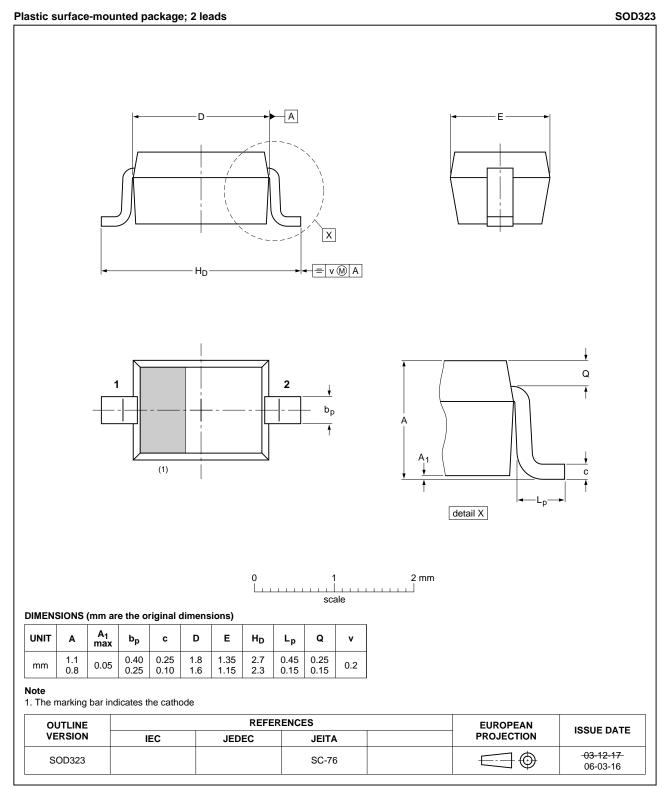






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#### PACKAGE OUTLINE



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BB131

#### DATA SHEET STATUS

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
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#### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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